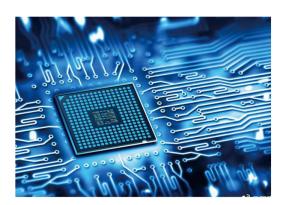


동광터크 (DONGKWANG TECH) TARGET 소개자료

1. Product Application



Semiconductor display (TFT, OLED)



Semiconductor chip



Solar power



LOW-E glass



Decoration Tools



Computer hard drives



2. Equipment & Capacity

Production capacity:

- 1. ITO targets production capacity 120t / year, and plan to expand to 400t / year gradually .
- 2. Mo target: Rotary Mo target 500pcs / year, planar Mo target 700pcs / year
- 3. Cu target: Rotary Cu target 1500pcs / year, planar Cu target 25000pcs / year
- 4. Al target: Rotary Al target 1500pcs / year, planar Al target 5000pcs / year
- 5. Other types of metal targets: 1000 tons / year

Main equipments : Ten thousand ton isostatic press, ultra high temperature sintering fur nace, vacuum melting furnace, forging, rolling, heat treatment, precision machining, 5m l arge ultrasonic C-SCAN testing, precision chemical composition and metallographic exa mination, Experimental sputter coating machine, super clean room.



3. Products and customers

Application	Target material	Application area	
Semiconductor display (TFT,OLED)	High purity Al, Cu, Mo,Ti, (ITO)	HDTV, OLED, laptop, mobile phone	
Semiconductor chip	Semiconductor chip Ultra high purity Al, Cu, Mo, Ni, etc. Key materials for ma integrated circuit		
Solar PV	Zinc oxide aluminum, Cr, CuNi, NbOx, etc	Thin film solar cell	
LOW-E glass	Zinc oxide aluminum, SiAl, ZnAl, NbOx, etc	Reduce UV rays, heat insulation	
Decoration Tools	Cr, TiAl, Ti, Ni, Si, etc	Wear resistance/wear reduction/ corrosion resistance/decoration	
Optical, Optical storage	Si, Nb, Al, Ti, Ta, etc	Optical lens, computer hard disk	



4. Semiconductor display(TFT, OLED) target(1)

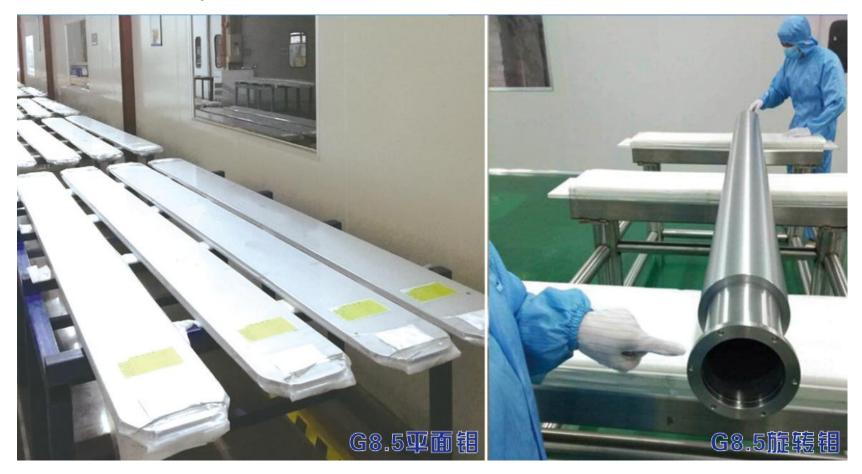
- High Gerenation: G11,G10.5,G10,G8.5...G5,TFT,OLED Target
- Size: Length up to 4000mm
- Suit for: AMAT,ULVAC coating systems

Product	Purity	Planar target	Rotary target	
Мо	3N5			
AI	5N	Whole piece	Whole piece	
Cu	4N	G5,G6,G8.5,G10.5/G11	G5,G6,G8.5,G10.5/G11	
Ti	2N8			
ITO	4N	Multi-pcs construction. Single pc up to 1000mm G5,G6,G8.5,G10.5/G11	Bonding with multi-sections. Single pc up to 400mm, G5,G6,G8.5,G10.5/G11	



4. Semiconductor display(TFT, OLED) target(2)

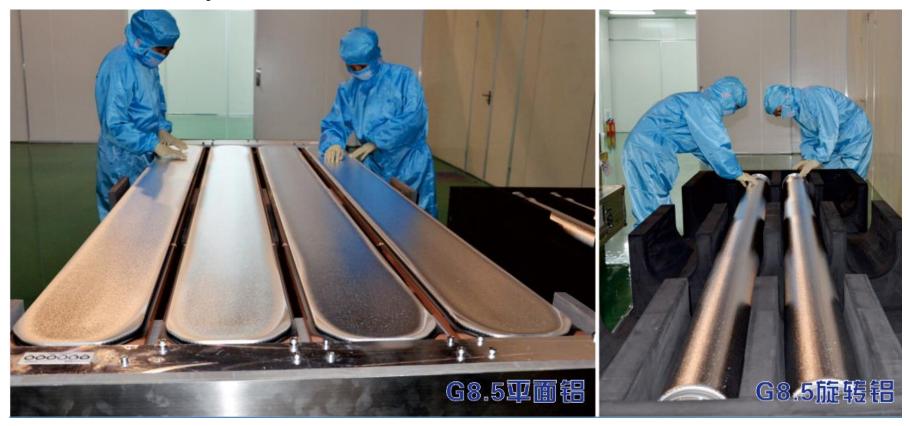
Planar Mo & Rotary Mo





4. Semiconductor display(TFT, OLED) target(3)

Planar Al & Rotary Al





4. Semiconductor display(TFT, OLED) target(4)

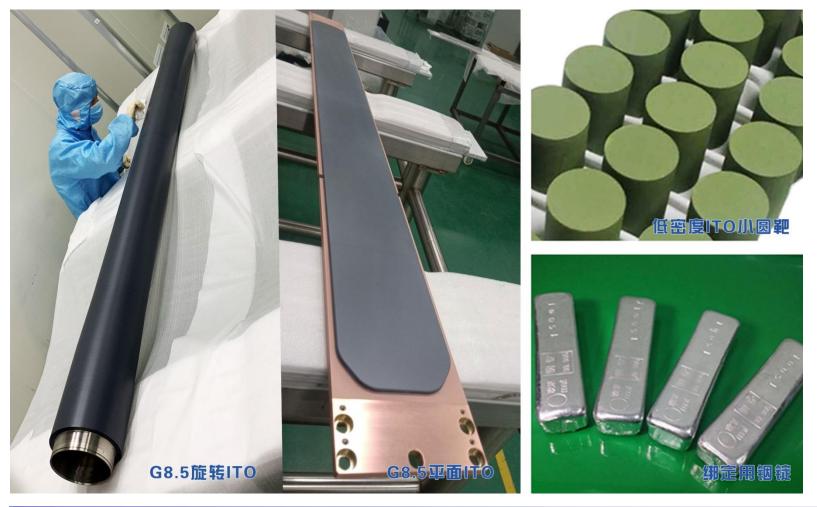
Planar Cu & Rotary Cu





4. Semiconductor display(TFT, OLED) target(5)

ITO Target





5. Touch Panel Targets(1)







Phone

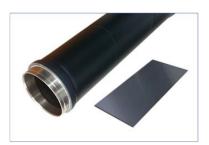
Ipad

Notebook

Product	Target material	Target size	
Capacitive/Resistive Touch Panel targets	MoX, AIX ,Si, NbOx, ITO etc		
ITO conductive glass targets	Si, NbOx, ITO	G5,G8.5,G10,G10.5,G11, length up to 4000mm	
ITO conductive film targets	Si, NbOx, ITO	TOTOLIU	



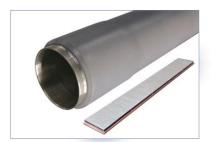
5. Touch Panel Targets(2)



ITO



Monolithic Rotary Mo/MoX



Planar Si & Monolithic Rotary Si



Cu/CuNi



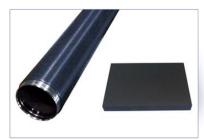
Monolithic Rotary Al/AlX



Nb



MoX,Single pc length up to1500mm

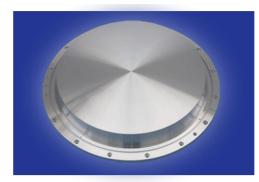


NbOx

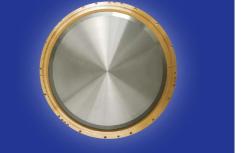


6. Electronics& Semiconductors Targets(1)

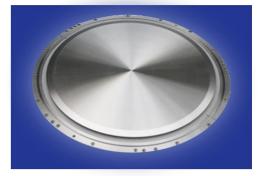
Semiconductor target



High purity Al



High purity Ta



High purity Ti



High purity Wti



High purity Cu



High purity Ni

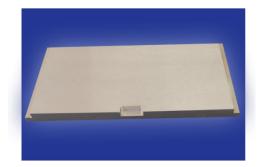


6. Electronics& Semiconductors Targets(2)

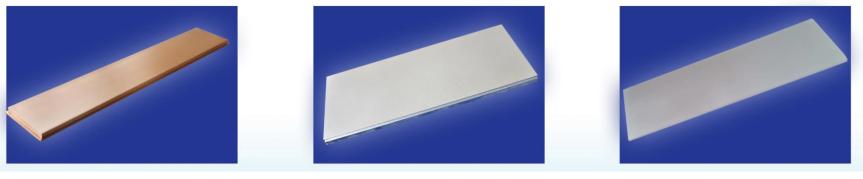
Targets for resistor and capacitor NiCr 80/20,70/30,60/40,50/50 NiCrSi

SiCr

Targets for PCB/NCVM/EMI



NiCr alloy target



Cu

Al

Ti



7. Architectural and automotive glass, web coating targets(1)

As a major long-term supplier to this industry, produces a wide range of targets co,partible for using in common coating system e.g. VON ARDENNE, LEYBOLD, BOC AIRCO,AMAT etc., and ot her coating system designed by customer themselves.

Rotary target		Planar target		Target size		
SiAl	ZnAl	TiOx	Cr	Ti	NiCr	
NiCr	ZnSn	NbOx	Sn	Cu	SS	Length up to 4000mm
Tì	Cr	ZnSnSb	Si	Si NbOx		Base on drawing
Sn	Nb	AZO	AZO			



7. Architectural and automotive glass, web coating targets(2)



SiAl AZO TiOx 市欧莱测 巴材 dong 民公司 Co.,Lto 提供一流材 www.omat.com uttoring Ta Zn'Al ZhSn



8. Decoration and tool & die targets(1)

- Decorative coatings: We offers a wide range of sputter targets which, as coatings, provide gold, silver, black and rainbow color simulation on such items as watches, glasses, pens, art-work and domestic fittings.
- Hard Coatings: For cutting tools where friction reduction, hard-wearing surfaces and corrosion resistance are re quired. We offers total coating solutions with its range of sputter targets.
- Adopted by the hot isostatic pressing (HIP), vacuum melting or spraying process, which provides an average gra in size of typically <50um</p>
- Available target list:

Cr	AlTi	AlCr	TiAi	Ti
Zr	Ni	W	SS	Graphite
Si	InSn	NbOx	Nitride	Boride

These are principally available in disc (60/65/100mm20/30/40/45mm, rotary and planar target



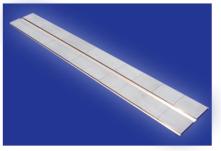
8. Decoration and tool & die targets(2)



Cr/AlCr/Ti/TiAl/Zr/



Graphite



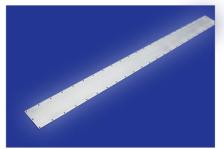
Si



Planar TiAl







Planar Cr, length 2000mm







Planar AlCr, length 2000mm







9. Solar pv&solar heating targets(1)

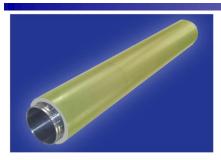




- SOLAR PV targets suit for: VON ARDENNE, SINGULUS, GLOBAL SOLAR coating system
- CIGS, a-Si, CdTe Thin film solar cell target
- ➤ Mo, Al, ITO Electrode/conductive layer target
- ➢ AZO, ITO Transparent conductive layer 、 ZnO target
- Target size: Single pc up to 4000mm



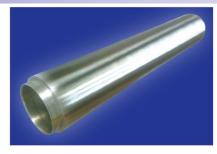
9. Solar pv&solar heating targets(2)



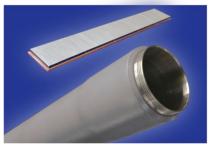
AZO



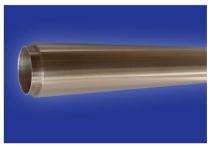
Cr



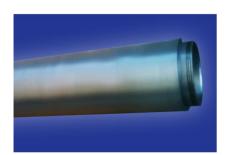
Al



Si



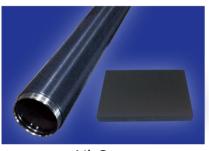
CuNi



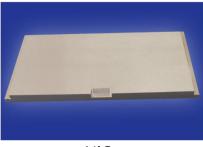
Monolithic rotary Mo



Мо



NbOx



NiCr



10. Optics, Optical Communication, Optical storage targets(1)

- We supplies targets for thin film filters(TFF)and DWDM, e.g. Ta205(p 90X10mm) and grain(1-5mm), Sio2 circle and grain, high purity larg e size Ta, Nb, Si targets etc.
- Applied for common coating systems like LEYBOLD, OPTORUN, SHI NCRON and WEECO. We also supplies targets and high purity evap oration materials for optical glass, optical crystal and optical commu nication applications.

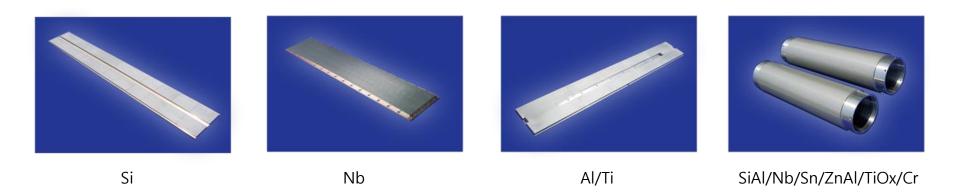


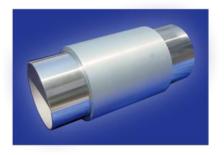






10. Optics, Optical Communication, Optical storage targets(2)

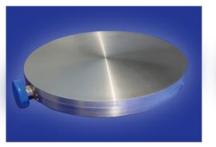




SiAl/Nb/Sn/ZnAl/TiOx/Cr



SiO2



Ta



Si



11. Bonding/Backing plate services(1)

We has developed a unique targets/backing plate metallizing technique which owns soli d engineering material and long term bonding technique background, can provide adva nced bonding service for brittle materials either with low or intermediate thermal expans ion or with high thermal expansion property, so as to achieve optimal sputter effect.

The Main Technical And Capacity:

1.Large scale BSM(back-side metallization) capability for sizes up to 1.8 meters in width a nd 3.5meters in length

- 2. Bonding of rotatable(cylindrical) targets in various materials and configuration
- 3. C-scan: Ultrasonic test equipment to verify bonding integrity

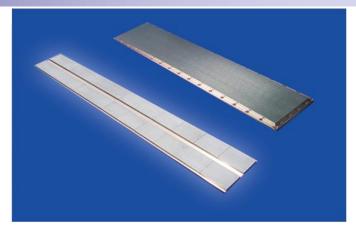
4.Precision machining/bonding capability for designing and building backing plates from a variety of materials, such as OFHC Copper, Ti-tanium, Stainless Steel, Molybdenum



11. Bonding/Backing plate services(1)



Bonding on rotary AZO target



Bonding on Si + Bonding on Nb



Bonding on ITO target



Bonding on Mo target

